

## Molding Type Module IGBT, 2 in 1 Package, 1200 V, 50 A


**INT-A-PAK**

### FEATURES

- Low  $V_{CE(on)}$  trench IGBT technology
- Low switching losses
- 10  $\mu$ s short circuit capability
- $V_{CE(on)}$  with positive temperature coefficient
- Maximum junction temperature 175 °C
- Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

| PRODUCT SUMMARY  |                 |
|--|-----------------|
| $V_{CES}$  | 1200 V          |
| $I_C$ at $T_C = 80\text{ °C}$                                  | 50 A            |
| $V_{CE(on)}$ (typical)<br>at $I_C = 50\text{ A}, 25\text{ °C}$ | 1.65 V          |
| Speed  | 8 kHz to 30 kHz |
| Package  | INT-A-PAK       |
| Circuit  | Half bridge     |

### TYPICAL APPLICATIONS

- UPS (Uninterruptable Power Supply)
- Electronic welders
- Switching mode power supplies

### DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as UPS and SMPS.

| ABSOLUTE MAXIMUM RATINGS ( $T_C = 25\text{ °C}$ unless otherwise noted) |                |                                      |          |       |
|---|----------------|--------------------------------------|----------|-------|
| PARAMETER   | SYMBOL         | TEST CONDITIONS                      | MAX.     | UNITS |
| Collector to emitter voltage  | $V_{CES}$      |                                      | 1200     | V     |
| Gate to emitter voltage   | $V_{GES}$      |                                      | $\pm 20$ |       |
| Collector current   | $I_C$          | $T_C = 25\text{ °C}$                 | 100      | A     |
|   |                | $T_C = 80\text{ °C}$                 | 50       |       |
| Pulsed collector current  | $I_{CM}^{(1)}$ | $t_p = 1\text{ ms}$                  | 100      |       |
| Diode continuous forward current  | $I_F$          |                                      | 50       |       |
| Diode maximum forward current   | $I_{FM}^{(1)}$ |                                      | 100      |       |
| Maximum power dissipation   | $P_D$          | $T_J = 175\text{ °C}$                | 405      | W     |
| RMS isolation voltage   | $V_{ISOL}$     | $f = 50\text{ Hz}, t = 1\text{ min}$ | 2500     | V     |

**Note**

<sup>(1)</sup> Repetitive rating; pulse width limited by maximum junction temperature.

| IGBT ELECTRICAL SPECIFICATIONS ( $T_C = 25\text{ °C}$ unless otherwise noted) |               |  |      |      |      |       |
|---|---------------|--|------|------|------|-------|
| PARAMETER   | SYMBOL        | TEST CONDITIONS  | MIN. | TYP. | MAX. | UNITS |
| Collector to emitter breakdown voltage  | $V_{(BR)CES}$ | $T_J = 25\text{ °C}$   | 1200 | -    | -    | V     |
| Collector to emitter voltage  | $V_{CE(on)}$  | $V_{GE} = 15\text{ V}, I_C = 50\text{ A}, T_J = 25\text{ °C}$  | -    | 1.90 | 2.35 |       |
|   |               | $V_{GE} = 15\text{ V}, I_C = 50\text{ A}, T_J = 175\text{ °C}$ | -    | 2.50 | -    |       |
| Gate to emitter threshold voltage   | $V_{GE(th)}$  | $V_{CE} = V_{GE}, I_C = 1.4\text{ mA}, T_J = 25\text{ °C}$     | 5.0  | 5.5  | 7.5  |       |
| Collector cut-off current   | $I_{CES}$     | $V_{CE} = V_{CES}, V_{GE} = 0\text{ V}, T_J = 25\text{ °C}$    | -    | -    | 5.0  | mA    |
| Gate to emitter leakage current   | $I_{GES}$     | $V_{GE} = V_{GES}, V_{CE} = 0\text{ V}, T_J = 25\text{ °C}$    | -    | -    | 400  | nA    |



| SWITCHING CHARACTERISTICS                |               |   |      |      |      |            |
|--|---------------|---|------|------|------|------------|
| PARAMETER                                | SYMBOL        | TEST CONDITIONS   | MIN. | TYP. | MAX. | UNITS      |
| Turn-on delay time                       | $t_{d(on)}$   | $V_{CC} = 600\text{ V}, I_C = 50\text{ A}, R_g = 15\ \Omega,$<br>$V_{GE} = \pm 15\text{ V}, T_J = 25\text{ }^\circ\text{C}$               | -    | 148  | -    | ns         |
| Rise time                                | $t_r$         |   | -    | 84   | -    |            |
| Turn-off delay time                      | $t_{d(off)}$  |   | -    | 245  | -    |            |
| Fall time                                | $t_f$         |   | -    | 251  | -    |            |
| Turn-on switching loss                   | $E_{on}$      |   | -    | 5.51 | -    |            |
| Turn-off switching loss                  | $E_{off}$     | -   | 2.70 | -    |      |            |
| Turn-on delay time                       | $t_{d(on)}$   | $V_{CC} = 600\text{ V}, I_C = 50\text{ A}, R_g = 15\ \Omega,$<br>$V_{GE} = \pm 15\text{ V}, T_J = 125\text{ }^\circ\text{C}$              | -    | 263  | -    | ns         |
| Rise time                                | $t_r$         |   | -    | 81   | -    |            |
| Turn-off delay time                      | $t_{d(off)}$  |   | -    | 256  | -    |            |
| Fall time                                | $t_f$         |   | -    | 292  | -    |            |
| Turn-on switching loss                   | $E_{on}$      |   | -    | 6.63 | -    |            |
| Turn-off switching loss                  | $E_{off}$     | -   | 3.25 | -    |      |            |
| Input capacitance                        | $C_{ies}$     | $V_{GE} = 0\text{ V}, V_{CE} = 30\text{ V}, f = 1.0\text{ MHz}$   | -    | 6.24 | -    | nF         |
| Output capacitance                       | $C_{oes}$     |   | -    | 0.23 | -    |            |
| Reverse transfer capacitance             | $C_{res}$     |   | -    | 0.15 | -    |            |
| SC data                                  | $I_{SC}$      | $t_p \leq 10\ \mu\text{s}, V_{GE} = 15\text{ V}, T_J = 125\text{ }^\circ\text{C},$<br>$V_{CC} = 600\text{ V}, V_{CEM} \leq 1200\text{ V}$ | -    | 450  | -    | A          |
| Stray inductance                         | $L_{CE}$      |   | -    | -    | 30   | nH         |
| Module lead resistance, terminal to chip | $R_{CC'+EE'}$ |   | -    | 0.75 | -    | m $\Omega$ |

| DIODE ELECTRICAL SPECIFICATIONS ( $T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted) |           |  |                                   |      |      |       |               |
|--|-----------|--|-----------------------------------|------|------|-------|---------------|
| PARAMETER  | SYMBOL    | TEST CONDITIONS  | MIN.                              | TYP. | MAX. | UNITS |               |
| Forward voltage  | $V_F$     | $I_F = 50\text{ A}$  | $T_J = 25\text{ }^\circ\text{C}$  | -    | 1.85 | 2.25  | V             |
|  |           |  | $T_J = 125\text{ }^\circ\text{C}$ | -    | 1.95 | -     |               |
| Reverse recovery charge  | $Q_{rr}$  | $I_F = 50\text{ A}, V_R = 600\text{ V},$<br>$di_f/dt = -654\text{ A}/\mu\text{s}$<br>$V_{GE} = -15\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$  | -    | 3.1  | -     | $\mu\text{C}$ |
|  |           |  | $T_J = 125\text{ }^\circ\text{C}$ | -    | 6.1  | -     |               |
| Peak reverse recovery current  | $I_{rr}$  | $I_F = 50\text{ A}, V_R = 600\text{ V},$<br>$di_f/dt = -654\text{ A}/\mu\text{s}$<br>$V_{GE} = -15\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$  | -    | 24   | -     | A             |
|  |           |  | $T_J = 125\text{ }^\circ\text{C}$ | -    | 31   | -     |               |
| Reverse recovery energy  | $E_{rec}$ | $I_F = 50\text{ A}, V_R = 600\text{ V},$<br>$di_f/dt = -654\text{ A}/\mu\text{s}$<br>$V_{GE} = -15\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$  | -    | 0.98 | -     | mJ            |
|  |           |  | $T_J = 125\text{ }^\circ\text{C}$ | -    | 2.06 | -     |               |

| THERMAL AND MECHANICAL SPECIFICATIONS    |            |                          |            |      |      |                  |
|--|------------|--------------------------|------------|------|------|------------------|
| PARAMETER                                | SYMBOL     | TEST CONDITIONS          | MIN.       | TYP. | MAX. | UNITS            |
| Operating junction temperature           | $T_J$      |                          | -          | -    | 175  | $^\circ\text{C}$ |
| Storage temperature range                | $T_{Stg}$  |                          | -40        | -    | 125  | $^\circ\text{C}$ |
| Junction to case                         | $R_{thJC}$ | IGBT                     | -          | -    | 0.37 | K/W              |
|  |            | Diode                    | -          | -    | 0.49 |                  |
| Case to sink (Conductive grease applied) | $R_{thCS}$ |                          | -          | 0.05 | -    |                  |
| Mounting torque                          |            | Power terminal screw: M5 | 2.5 to 5.0 |      |      | Nm               |
|  |            | Mounting screw: M6       | 3.0 to 5.0 |      |      |                  |
| Weight                                   |            | Weight of module         | -          | 150  | -    | g                |

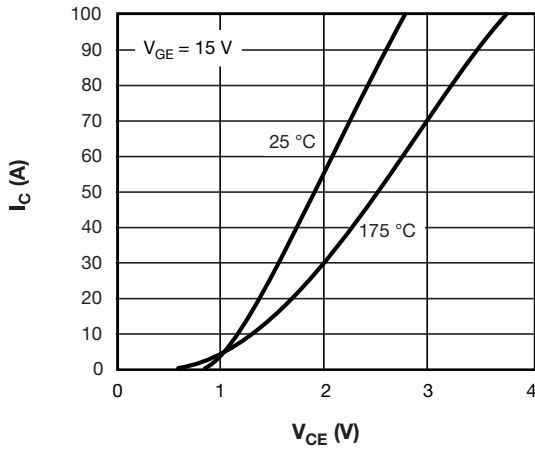


Fig. 1 - IGBT Typical Output Characteristics

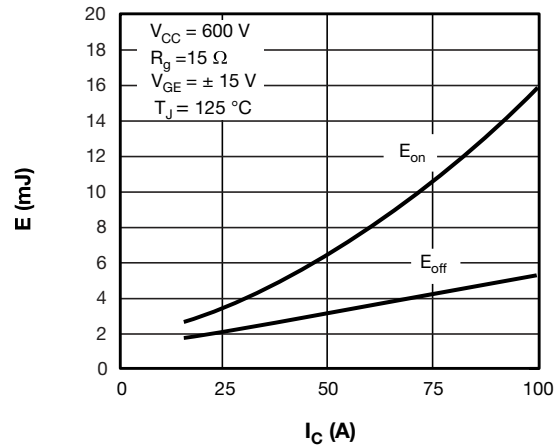


Fig. 3 - IGBT Switching Loss vs.  $I_C$

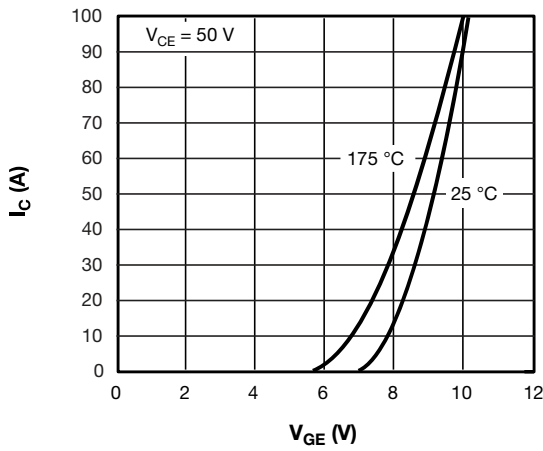


Fig. 2 - IGBT Transfer Characteristics

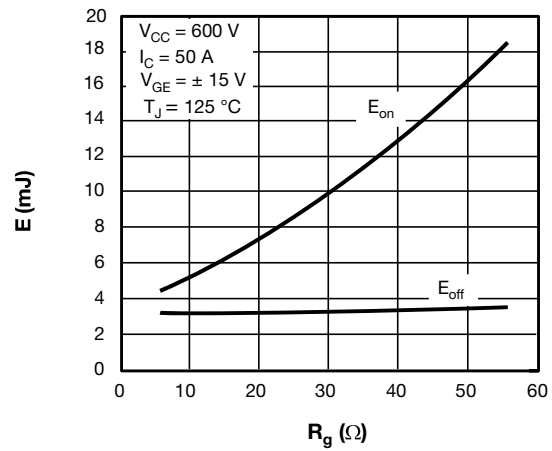


Fig. 4 - IGBT Switching Loss vs.  $R_G$

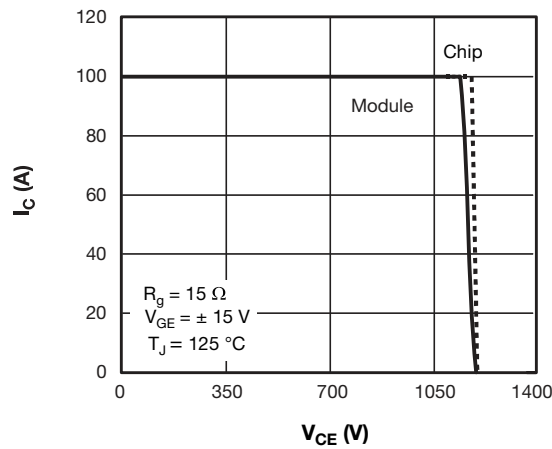


Fig. 5 - RBSOA

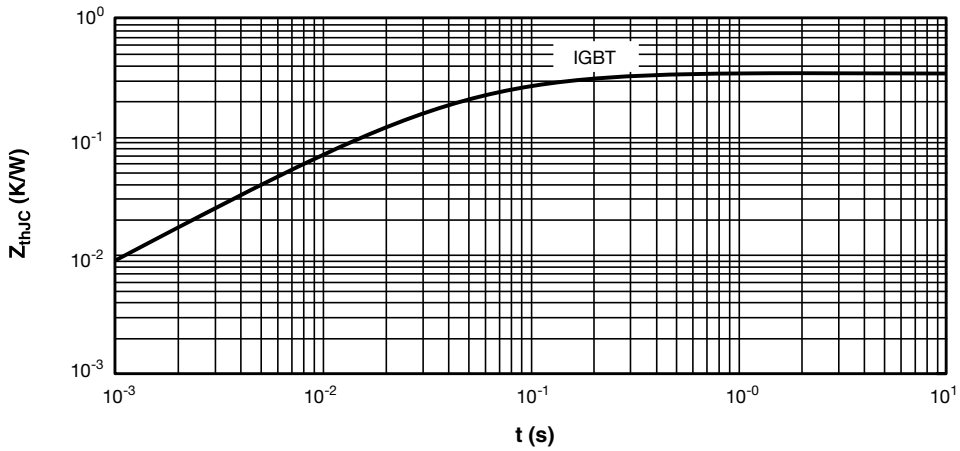


Fig. 6 - IGBT Transient Thermal Impedance

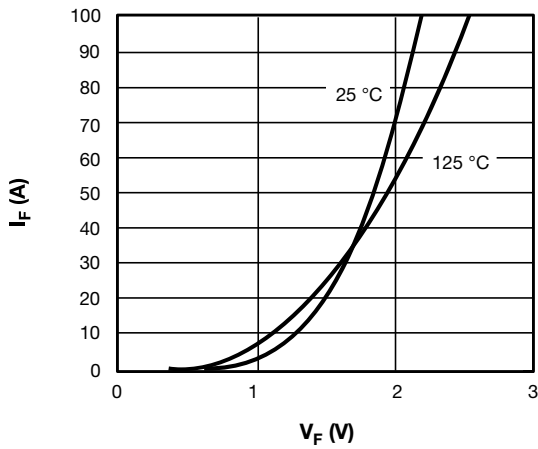


Fig. 7 - Diode Forward Characteristics

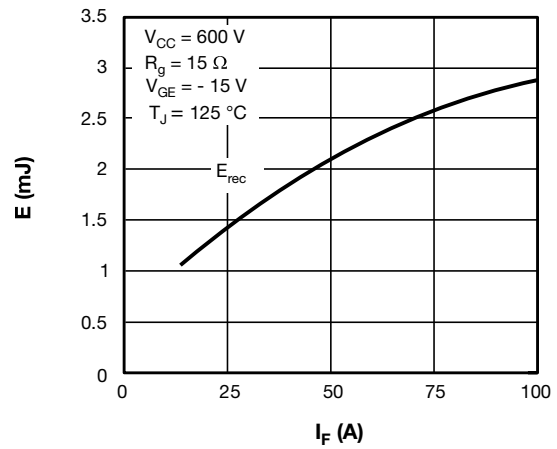


Fig. 8 - Diode Switching Loss vs.  $I_F$

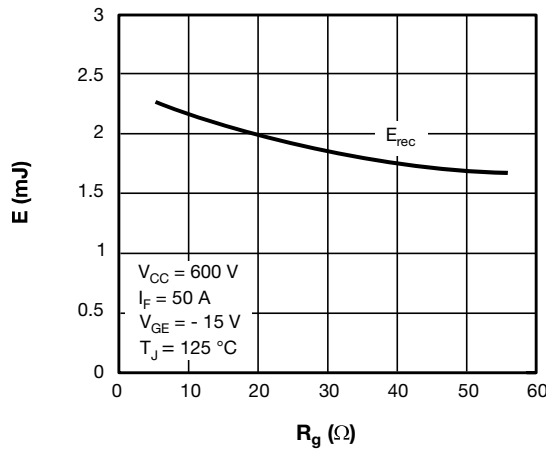


Fig. 9 - Diode Switching Loss vs.  $R_G$

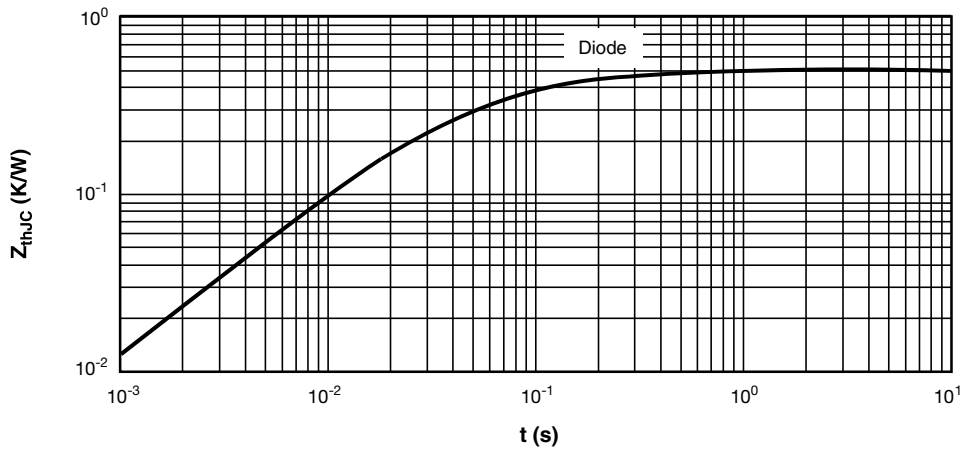
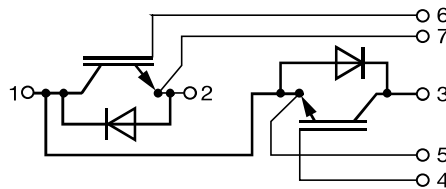


Fig. 10 - Diode Transient Thermal Impedance

**CIRCUIT CONFIGURATION**



| LINKS TO RELATED DOCUMENTS |  |
|----------------------------|--|
| Dimensions                 | <a href="http://www.vishay.com/doc?95524">www.vishay.com/doc?95524</a> |



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